

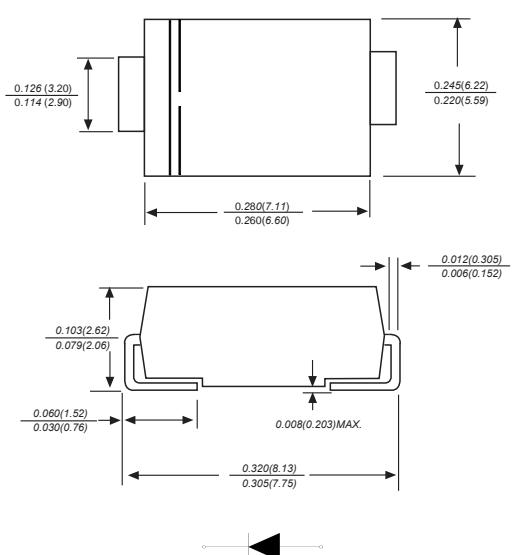


SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ For surface mounted applications
- ◆ Metal silicon junction,majority carrier conduction
- ◆ Low power loss,high efficiency
- ◆ Built-in strain relief,ideal for automated placement
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed:
250 °C/10 seconds at terminals

DO-214AB/SMC ROHS COMPLIANT



Dimensions in inches and (millimeters)

Mechanical Data

Case : JEDEC DO-214AB/SMC molded plastic body
Terminals : Solderable per MIL-STD-750, Method 2026
Polarity : Color band denotes cathode end
Mounting Position : Any
Weight : 0.007 ounce, 0.25 grams

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz,resistive or inductive load,for capacitive load current derate by 20%.

Parameter	SYMBOLS	MDD SK102C	MDD SK103C	MDD SK1035C	MDD SK104C	MDD SK1045C	MDD SK106C	MDD SK108C	MDD SK1010C	UNITS
Marking Code										
Maximum repetitive peak reverse voltage	V _{RRM}	20	30	35	40	45	60	80	100	V
Maximum RMS voltage	V _{RMS}	14	21	24.5	28	31.5	42	56	70	V
Maximum DC blocking voltage	V _{DC}	20	30	35	40	45	60	80	100	V
Maximum average forward rectified current at TL(see fig.1)	I _(AV)						10.0			A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}						250			A
Maximum instantaneous forward voltage at 10.0A	V _F				0.65			0.85		V
Maximum DC reverse current T _A =25°C at rated DC blocking voltage T _A =125°C	I _R				1.0					mA
					20					
Typical junction capacitance (NOTE 1)	C _J				500					pF
Typical thermal resistance (NOTE 2)	R _{θJA}				18.0					°C/W
Operating junction temperature range	T _J				-50 to +150					°C
Storage temperature range	T _{STG}				-50 to +150					°C

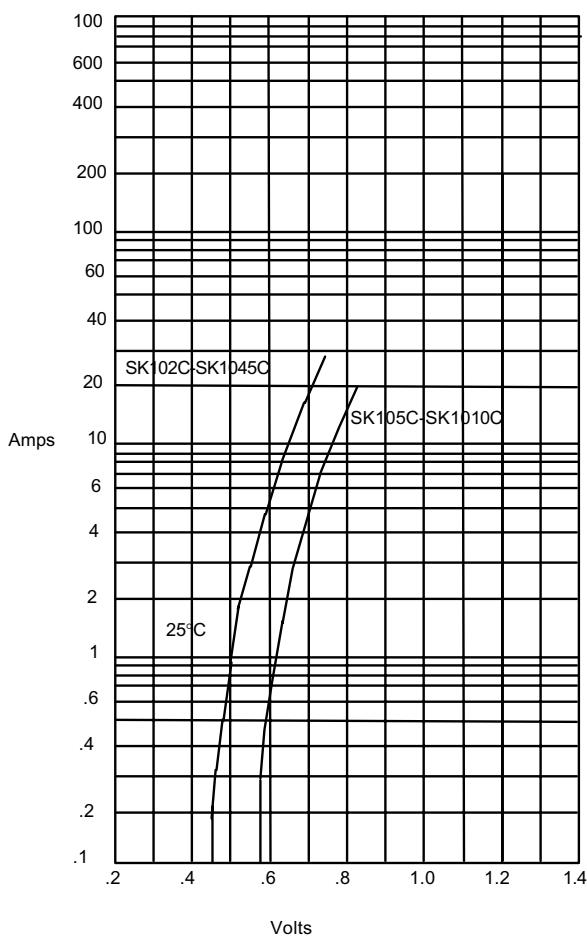
Note: 1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

2. P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas



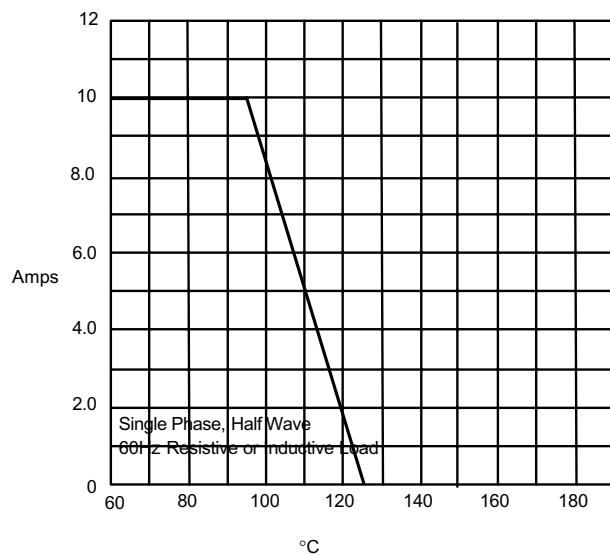
Typical Characteristics

Figure 1
Typical Forward Characteristics



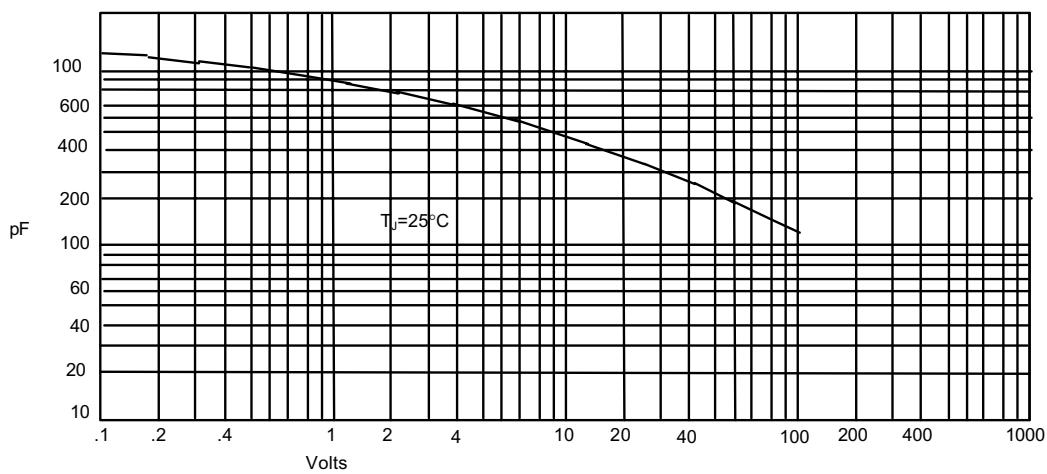
Instantaneous Forward Current - Amperes versus
Instantaneous Forward Voltage - Volts

Figure 2
Forward Derating Curve



Average Forward Rectified Current - Amperes versus
Lead Temperature - C

Figure 3
Junction Capacitance



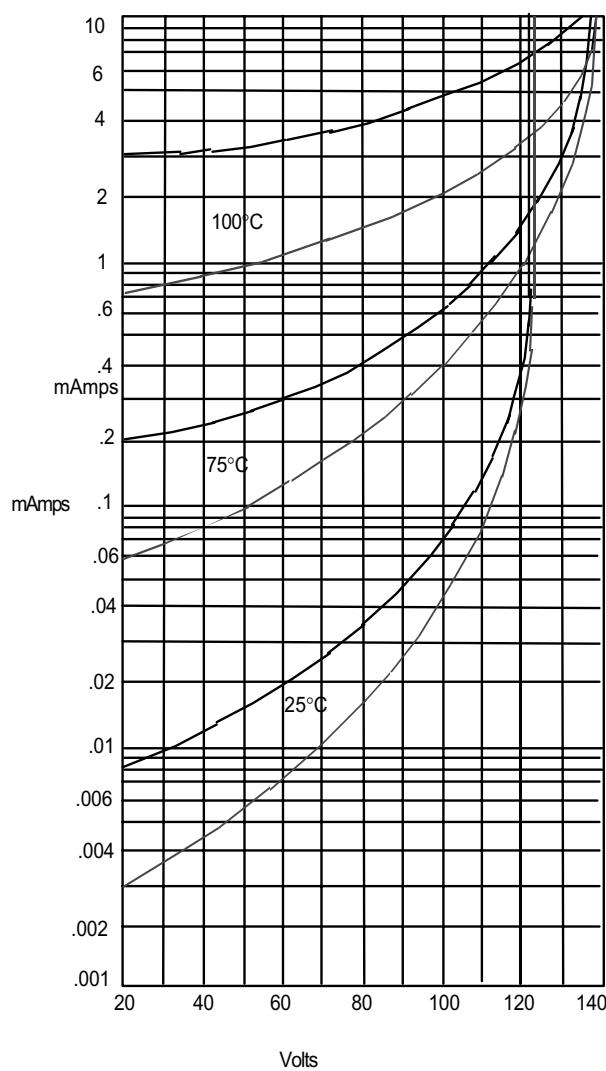
Junction Capacitance - pF versus

The curve above is for reference only.



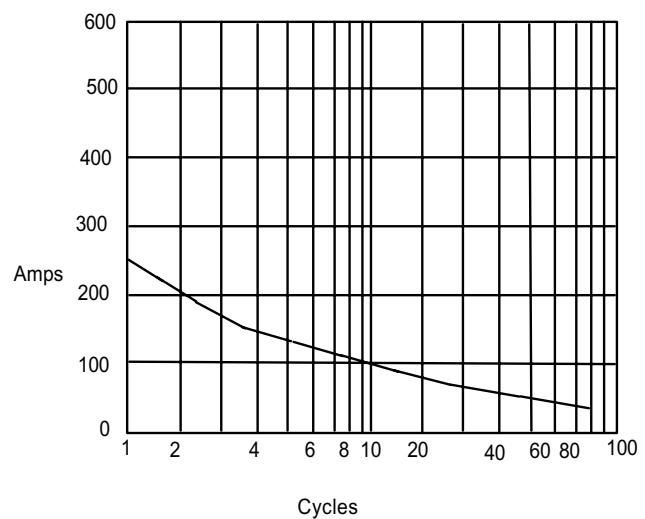
Typical Characteristics

Figure 4
Typical Reverse Characteristics



Instantaneous Reverse Leakage Current - MicroAmperes versus
Percent Of Rated Peak Reverse Voltage - Volts

Figure 5
Peak Forward Surge Current



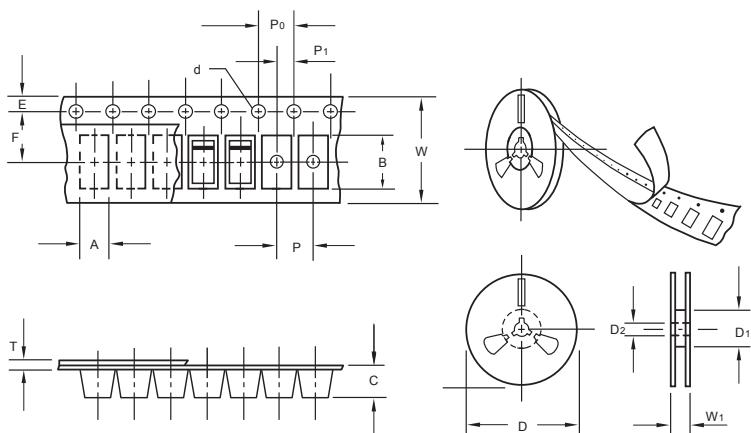
Peak Forward Surge Current - Amperes versus Number Of
Cycles At 60Hz - Cycles

SK102C-SK1045C _____
SK105C-SK1010C _____

The curve above is for reference only.



Packing information



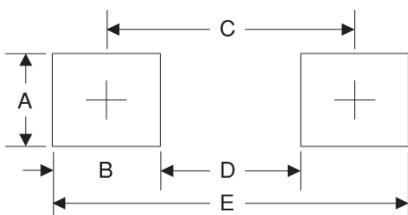
Item	Symbol	Tolerance	SMC
Carrier width	A	0.1	6.15
Carrier length	B	0.1	8.41
Carrier depth	C	0.1	2.42
Sprocket hole	d	0.05	1.50
13" Reel outside diameter	D	2.0	330.00
13" Reel inner diameter	D ₁	min	50.00
Feed hole diameter	D ₂	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	7.50
Punch hole pitch	P	0.1	8.00
Sprocket hole pitch	P ₀	0.1	4.00
Embossment center	P ₁	0.1	2.00
Overall tape thickness	T	0.1	0.25
Tape width	W	0.3	16.00
Reel width	W ₁	1.0	16.50

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (mm)	BOX (pcs)	INNER BOX (mm)	REEL DIA. (mm)	CARTON SIZE (mm)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SMC	13"	3,000	4.0	6000	190*190*41	330	365*365*340	42000	14.0

Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	4.3	0.170
B	4.1	0.160
C	7.9	0.311
D	3.8	0.150
E	12	0.472